

AD-A086 805

MARYLAND UNIV COLLEGE PARK DEPT OF CHEMISTRY

F/G 9/2

A DIGITAL TEMPERATURE CONTROL AND MEASUREMENT SYSTEM.(U)

JUL 80 R B STREMB, B K DAS, W T ANGEL

N00014-79-C-0008

UNCLASSIFIED

TR-1

NL

1 OF 1  
AD  
A086805

END  
DATE  
FILMED  
8-80  
DTIC

# LEVEL

OFFICE OF NAVAL RESEARCH

Contract N00014-79-C-0008

Task No. NR 051-701

TECHNICAL REPORT NO. 1

A Digital Temperature Control  
and Measurement System

by

R. B. Strem, B. K. Das, W. T. Angel,  
J. T. Siewick, S. C. Greer, and  
C. T. Van Degrift

Prepared for Publication  
in the  
Review of Scientific Instruments

University of Maryland  
Department of Chemistry  
College Park, Maryland 20742

July 4, 1980

Reproduction in whole or in part is permitted for any purposes of  
the United States Government.

This document has been approved for public release and sale;  
its distribution is unlimited.

80 7 17 003

ADA086805

UIC FILE COPY

DTIC  
ELECTE  
JUL 17 1980  
S D C

REPORT DOCUMENTATION PAGE		READ INSTRUCTIONS BEFORE COMPLETING FORM
1. REPORT NUMBER 1	2. GOVT ACCESSION NO. AD A086805	3. RECIPIENT'S CATALOG NUMBER
4. TITLE (and Subtitle) A DIGITAL TEMPERATURE CONTROL AND MEASUREMENT SYSTEM.		5. TYPE OF REPORT & PERIOD COVERED Technical Report.
6. AUTHOR(s) R.B./Strem B.K./Das W.T./Angel J.T./Siewick S.C./Greer (University of Maryland) and C.T. Van Degrikt (National Bureau of Standards)		7. PERFORMING ORG. REPORT NUMBER
8. PERFORMING ORGANIZATION NAME AND ADDRESS University of Maryland College Park, Maryland 20742		9. CONTRACT OR GRANT NUMBER(s) N00014-79-C-0008
10. CONTROLLING OFFICE NAME AND ADDRESS Office of Naval Research Arlington, VA 22217		11. PROGRAM ELEMENT, PROJECT, TASK AREA & WORK UNIT NUMBERS NR 051-701
12. MONITORING AGENCY NAME & ADDRESS (if different from Controlling Office)		13. REPORT DATE 4 July 1980
14. DISTRIBUTION STATEMENT (of this Report) This document has been approved for public release and sale; its distribution is unlimited.		15. NUMBER OF PAGES 19
16. DISTRIBUTION STATEMENT (of the abstract entered in Block 20, if different from Report)		17. SECURITY CLASS. (of this report) Unclassified
18. SUPPLEMENTARY NOTES Submitted for publication in The Review of Scientific Instruments		19. DECLASSIFICATION/DOWNGRADING SCHEDULE
20. KEY WORDS (Continue on reverse side if necessary and identify by block number) Digital Control Microcomputer Temperature Thermostat		
21. ABSTRACT (Continue on reverse side if necessary and identify by block number) We describe an automated digital temperature control and measurement system with a temperature resolution of 0.3 to 3.0 mK and operating in the temperature range -40°C to +70°C. IS DESCRIBED IN THIS REPORT.		

DD FORM 1 JAN 73 1473

EDITION OF 1 NOV 65 IS OBSOLETE  
S/N 0102-LF-014-6601

SECURITY CLASSIFICATION OF THIS PAGE (When Data Entered)

219625

JUN

A Digital Temperature Control  
and Measurement System

R. B. Strem,  
B. K. Das,  
W. T. Angel,  
J. T. Siewick,  
and  
S. C. Greer

Department of Chemistry  
The University of Maryland  
College Park, Maryland 20742

and

C. T. Van Degrift  
National Measurement Laboratory  
National Bureau of Standards  
Gaithersburg, Maryland 20234

Accession For	
NTIS S.M&I <input checked="checked" type="checkbox"/>	
DDC TAB <input type="checkbox"/>	
Unannounced <input type="checkbox"/>	
Justification	
By	
Distribution/	
Availability Codes	
Dist	Avail and/or special
A	

# ABSTRACT

We describe an automated digital temperature control and measurement system with a temperature resolution of 0.3 to 3.0 mK and operating in the temperature range  $-40^{\circ}\text{C}$  to  $+70^{\circ}\text{C}$ .

## I. INTRODUCTION

In our work on the thermodynamic properties of condensed phases, we must vary temperature in steps, controlling the temperature to a millidegree for as long as days at a time, until thermodynamic equilibrium is attained. It has been our practice to use analog controllers<sup>1-5</sup> to control our liquid baths, vacuum thermostats, and layered thermostats. With the appearance of inexpensive microcomputers, it now becomes feasible to construct a dedicated digital temperature control and measurement system. Such a controller can regulate and step the temperature automatically, while the computer also collects the data from the experimental transducers. The IEEE-488 interface bus<sup>6</sup> makes the hardware assembly straightforward; this bus is becoming ever more prevalent and its price is declining. The software has also been designed in a simple way, avoiding the more sophisticated approaches to such a "discrete-time" control system.<sup>7,8</sup>

We have built a digital temperature measurement and control and data acquisition system with proportional and integral temperature control.<sup>7</sup> With our vacuum thermostat and auxiliary cooler, we can control and measure temperature between  $-40^{\circ}\text{C}$  and  $+70^{\circ}\text{C}$  with an accuracy of 3 mK and a precision as small as 0.3 mK.

## II. HARDWARE

### A. Thermostat

Temperature control of better than a millidegree cannot be achieved without attention to the design of the thermostat itself. For a multistage vacuum thermostat, we require the minimization of heat transfer between stages and the maximization of heat transfer within each stage. To minimize transfer between stages, we evacuate the insulating space, we use materials of low thermal conductivity when we connect the stages, and we thermally ground all wires passing from stage to stage. To maximize thermal conductivity within a stage, we use materials of high thermal conductivity.

These principles are illustrated in the design of our vacuum thermostat, shown in Figure 1. The thermostat consists of an outer vacuum can (A), an inner can (radiation shield) (B), and the experimental stage (C). The two cans are evacuated independently through vacuum lines D. The vacuum lines and the connections between stages, E and F, are made of thin-walled stainless-steel tubing. Vacuum connections, indicated by closed circles, are made with elastomer o-rings.<sup>9,10</sup>

The outer vacuum can A is made entirely of aluminum, which provides good thermal conductivity with minimal weight. Around the outer can is wrapped a 3/8" o.d. aluminum

tubing at one turn per inch. The first stage of temperature control is a commercial cooler-circulator<sup>11</sup> which controls the temperature of a circulating fluid to 0.02 K and pumps the fluid through the aluminum tubing.

The second stage, radiation shield B, is made entirely of copper. A heater wire of #32 manganin wire with a total resistance of 338 $\Omega$  is wrapped in grooves (6 turns/in.) around the can and cemented with GE7031 varnish.

The experimental stage C is also made of copper. Experimental transducers may be mounted on the upper and lower surfaces of this stage.

Electrical leads for thermometers, heaters, thermocouples, etc. enter the thermostat through the vacuum lines D from a vacuum feed-through at the top of the vacuum lines. These wires, #30 enameled copper, are thermally grounded at E and F. The high-frequency feed-throughs necessary for certain of our experiments are coaxial SMA feed-throughs, mounted on flanges G and H.

A vacuum of about  $10^{-3}$  mmHg is maintained in the thermostat by means of a mechanical pump and a diffusion pump.

We estimate the total heat transfer from the interior of the thermostat to the cooler by radiation and conduction to be about 1 W when the vacuum can A is at 200K and the radiation shield and experimental stage are at 273 K.



An alternate design which we also use has all OFHC copper stages and indium o-rings. It is more expensive to build and more awkward to open and close, but has a particularly small out-gassing rate after a 100°C baking (less than 0.5  $\mu$ Hg per day). It can therefore be disconnected from its vacuum pump for prolonged periods to minimize mechanical vibrations.

#### B. Thermometry

The thermometers are a 100 $\Omega$  platinum thermometer (T1), mounted on the experimental stage C, and a thermistor (T2), mounted on the top flange H of the shield stage. The thermometer circuits are shown in Fig. 2. Each thermometer is in series with a standard resistor (R1 and R2) and a mercury battery. If  $R_T$  is the resistance of the thermometer,  $V_T$  the voltage drop across the thermometer, and  $V_S$  the voltage drop across the standard resistor, then  $R_T = (V_T/V_S)R_S$ . The thermistor is a bead thermistor<sup>12</sup> with an expected stability of 0.05% (or 13 mK) per year. The standard resistors<sup>13</sup> have a temperature coefficient of 1 ppm/K and a stability of 5 ppm/year.  $V_T$  and  $V_S$  are measured by a 6 1/2-digit voltmeter.

The platinum thermometer was calibrated to 1 mK by the National Bureau of Standards on the International Practical Temperature Scale of 1968. The thermistor was calibrated with respect to the platinum thermometer. Polynomial least squares fits were obtained of  $T(R_T)$  for the platinum thermometer and of  $T(\ln R_T)$  for the thermistor<sup>14-15</sup>. With a voltage resolution of 1  $\mu$ V, we can resolve 3 mK on the platinum thermometer and 0.3 mK on the thermistor. A second thermistor, mounted on the experimental stage, could easily be added to obtain the maximum temperature resolution.

### C. Feedback loop

Figure 2 is a block diagram of the hardware for the feedback loop. A scanner<sup>16</sup> (multiplexer) allows us to read all the thermometer voltage with one voltmeter.<sup>17</sup> Both the scanner and the voltmeter are under the control of the microcomputer.<sup>18</sup> The computer calculates the inner stage and experimental stage temperatures from the voltages, using the calibration equations. The temperature of the inner stage is compared to the desired temperature and the difference used to adjust the heater voltage by means of a digital-to-analog (D/A) converter<sup>19</sup> and a programmable power supply.<sup>20</sup>

The scanner, voltmeter, and D/A converter all connect to the computer via the IEEE-488 interface bus.<sup>21</sup>

### III. SOFTWARE

#### A. General

The computer brings the shield stage temperature to a desired value and controls it at that temperature until the experimental stage reaches that same temperature (within a given discrepancy) and remains so for a given time. Then the computer collects the experimental data, which are voltages on the other channels of the scanner (not shown in Fig. 2). The computer repeats the data collection a number of times and calculates a standard deviation for each voltage. During the data collection, the shield is not under temperature control, but the experimental stage is so isolated from the shield that any drift does not reach the experimental stage during the short time of the data collection ( a few minutes). The data are recorded on a printer which is connected to the computer by a IEEE-488-to-RS232 converter<sup>21</sup> and on a cassette tape. Then the computer increments the temperature and repeats the procedure given above.

## B. Feedback loop

The feedback control consists of integral and proportional control<sup>7,8</sup> of the shield temperature. The experimental stage temperature follows the shield temperature, mainly by gas conduction.

We use the following symbols:

$T_A$  = Ambient temperature of vacuum can

$T_D$  = Desired temperature of radiation shield and experimental stage

$T_S$  = Actual temperature of radiation shield

$T_E$  = Actual temperature of experimental stage

The "integral" control provides for most of the power required to the radiation shield heater to maintain a given difference between  $T_A$  and  $T_D$ . The power to the heater is proportional to the square of the heater voltage. We designate this "steady-state voltage" by  $V_{SS}$  and write

$$V_{SS}^2 \approx A_I (T_D - T_A) \quad (1)$$

where  $A_I$  is a constant.  $A_I$  can be determined empirically or estimated from the calculated heat loss. The functional relationship between  $V_{SS}$  and  $(T_D - T_A)$  may be more complex than equation (1), but equation (1) is an adequate first approximation.

The "proportional" control provides the power to attain  $T_D$  when  $T_S$  is less than  $T_D$ . If  $V_p$  is the needed heater

voltage, then

$$V_p^2 = A_p (T_D - T_S) \quad (2)$$

If we consider this contribution to be primarily the heating of the shield itself, ignoring the slow radiation loss to the experimental stage, then to a first approximation

$$A_p \approx RC_p/t \quad (3)$$

where R is the heater resistance,  $C_p$  is the heat capacity of the shield, and t is the time allowed for the temperature change. The "proportional gain"  $A_p$  can be initially set via equation (3), then adjusted by trial and error to achieve maximum gain without oscillation.<sup>7,8</sup>

The ~~square of the~~ total voltage applied to the heater is therefore

$$V = V_{SS} + V_p \quad (4)$$

If  $T_D$  is less than  $T_S$ , then the V is set to zero until  $T_D$  is attained. Cooling is such a slow process that "proportional" cooling is not necessary in our thermostat.

Figure 3 is a flow diagram of the control program, which is written in BASIC. The keyboard input allows the operator to enter the starting value of  $T_D$ , the desired temperature increments  $\Delta T$ , the number of increments N, and the circulating cooler temperature  $T_A$ . If  $T_D < T_S$ , then no voltage is applied to the heater. If  $T_D > T_S$ , then a voltage calculated from equations 1-4 is applied to the heater. This determination of  $T_S$  relative to  $T_D$  is done repeatedly, at a sampling interval of about 20 sec. The control do-loop continues as long as  $|T_D - T_S| > A$ , where A

is on the order of millidegrees or  $|T_S - T_E| > B$ , where B is on the order of 10-100 millidegrees.  $T_I$  is the running real time from the minicomputer clock. When  $|T_D - T_S| < A$  and  $|T_S - T_E| < B$ , then control is maintained for a time C, after which the data are collected,  $T_D$  is incremented, and a new control loop begins.

#### IV. PERFORMANCE

A typical plot of the temperature at the radiation shield as a function of time while the feedback control is in operation is shown in Figure 4. It is clear that the deviations are less than 1 mK. The actual deviations at the experimental stage can be expected to be an order of magnitude smaller. The time constant of the thermostat is quite long. When  $T_A$  is about 10 K less than  $T_D$ , an increase of 1 K requires about 5 hours and a decrease of 1 K requires about 8 hours.

The control system does not seem to be particularly sensitive to any of the control parameters - the constants  $A_I$  and  $A_p$  or the sampling time. Typically  $A_I = 20$  volts/deg and  $A_p = 40$  volts/deg.

#### V. ACKNOWLEDGEMENTS

We thank W. J. Bowers for technical assistance and D. T. Jacobs for helpful discussions. This work was supported in part by the Office of Naval Research.

## REFERENCES

1. D. Sarid and D.S. Cannell, Rev. Sci. Instrum. 45, 1082 (1974).
2. J. Dratler, Rev. Sci. Instrum. 45, 1435 (1974).
3. M. Grubic and V. Wurz, J. Phys. E 11, 692 (1978).
4. P. H. Sydenham and G. C. Collins, J. Phys. E. 8, 311 (1975).
5. T. M. Sporton, J. Phys. E. 5, 317 (1972).
6. Electronic Design 24, 124 (1974).
7. See, for example, James A. Cadzow and Hinrich R. Martens, Discrete-Time and Computer Control Systems (Prentice-Hall, Inc., Englewood Cliffs, NJ, 1970).
8. A. J. Allen and P. Atkinson, The Radio and Electronic Engineer 42, 55 (1972).
9. Low temperature compound E540-80, Parker Seal Co., Lexington, KY
10. Commercial names are given for completeness and do not indicate an endorsement by the National Bureau of Standards.
11. Circulator-cooler LT-50, Neslab Instruments Inc., Portsmouth, NH
12. Type S-1, 4K $\Omega$ , Thermometrics, Inc., Edison, NJ.
13. Type HP202, Vishay Resistor Products, Malvern, PA.
14. M. Sapoff, Measurement and Control 14, 110 (1980).
15. H. W. Trolander, D. A. Case, and R. W. Harruff, in Temperature, Its Measurement and Control in Science and Industry. 4, Part 2, 997 (Instrument Society of America, Pittsburgh, 1972).
16. Model 3495A, Hewlett-Packard Co., Palo Alto, CA.
17. Model 3455A, Hewlett-Packard Co., Palo Alto, CA.

18. Model PET 2001, Commodore Business Machines, Inc., Palo Alto, CA.
19. Model SN488-031, Kepco, Inc., Flushing, NY.
20. Model 1P-2728, Heath Co., Benton Harbor, MI.
21. E. Fisher and C. W. Jenson, PET and the IEEE 488 Bus (GPIB) (Osborne/McGraw-Hill, 1980).
22. Model TNW-2000, TNW Corp., San Diego, CA.

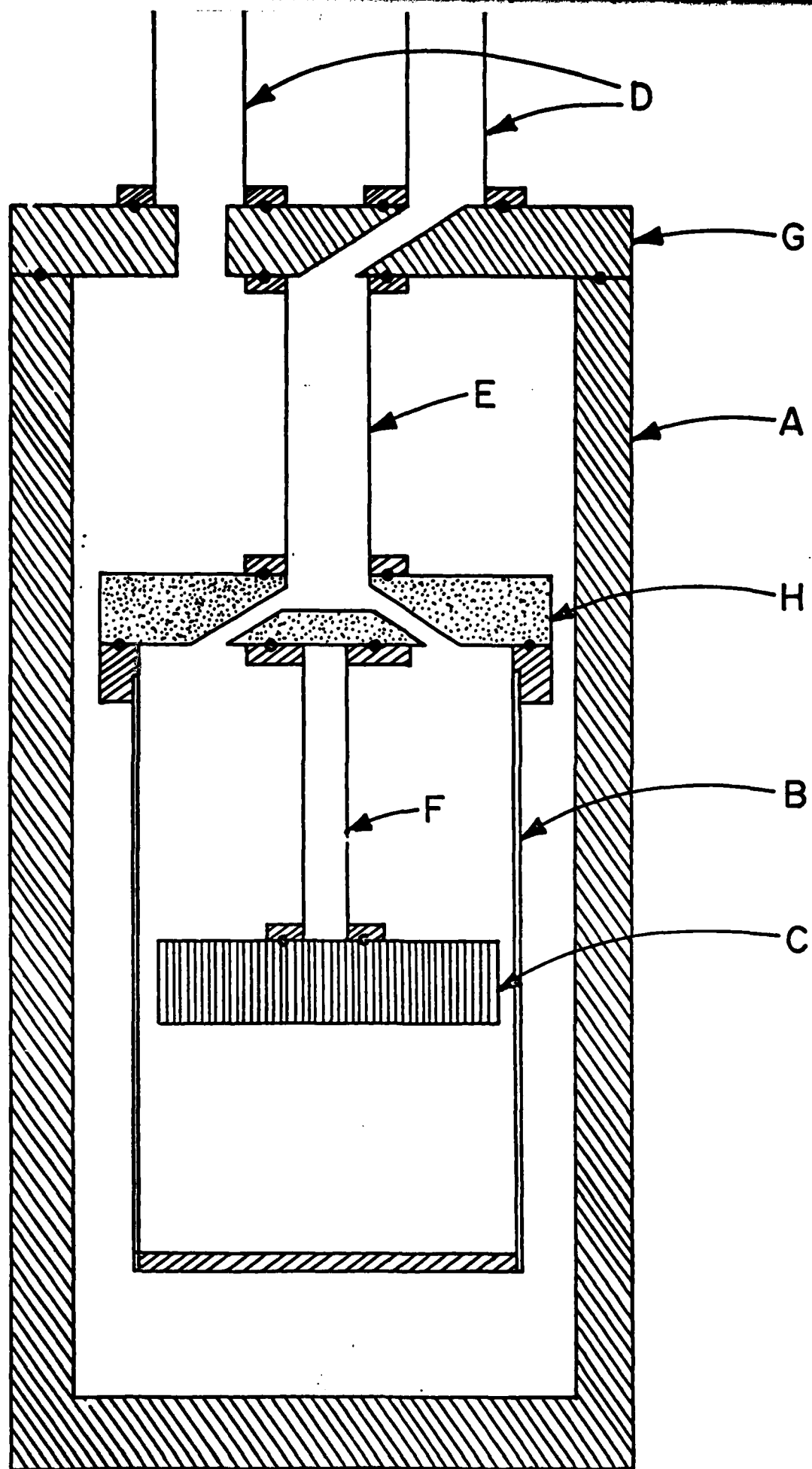


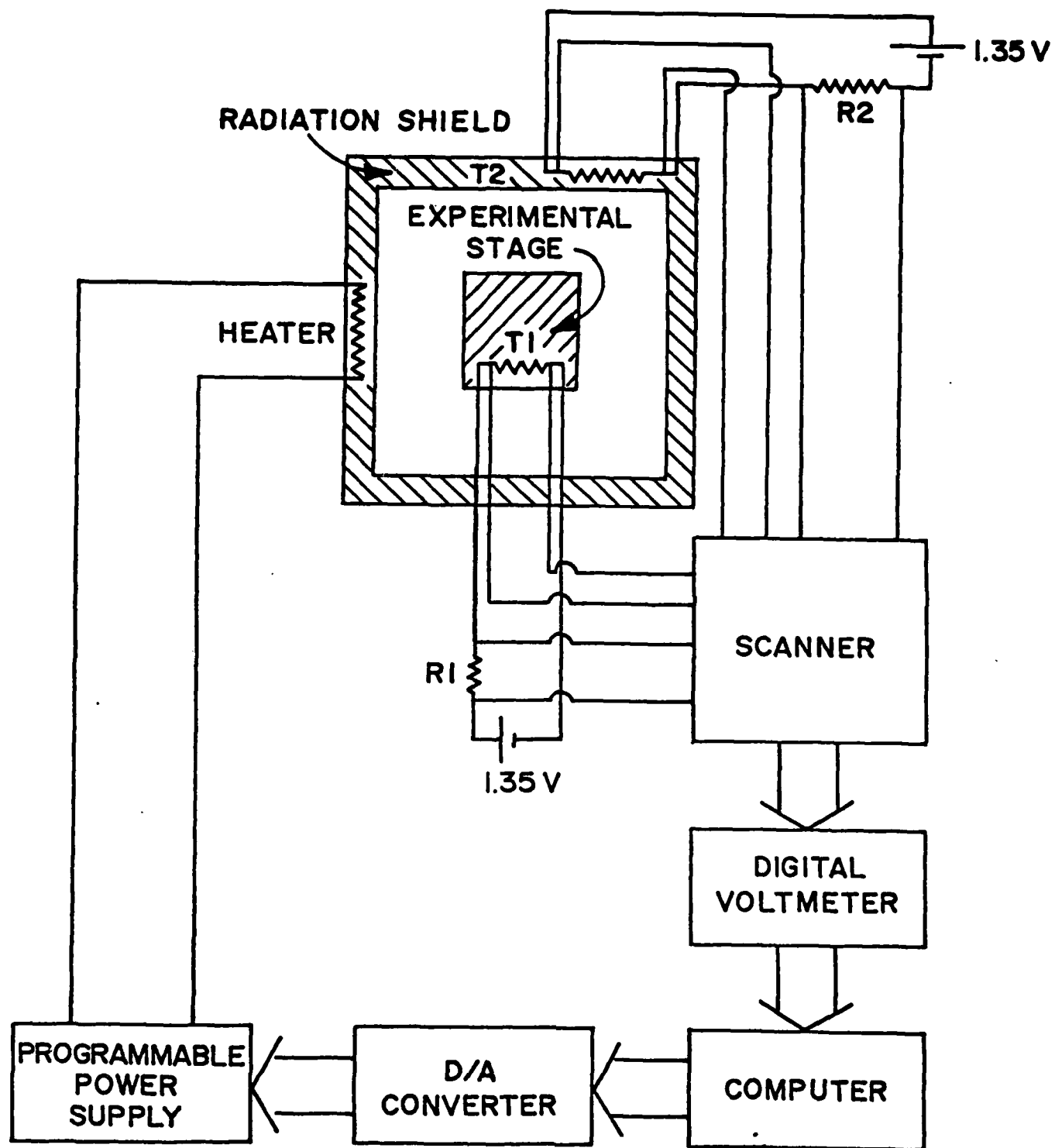
## FIGURE CAPTIONS

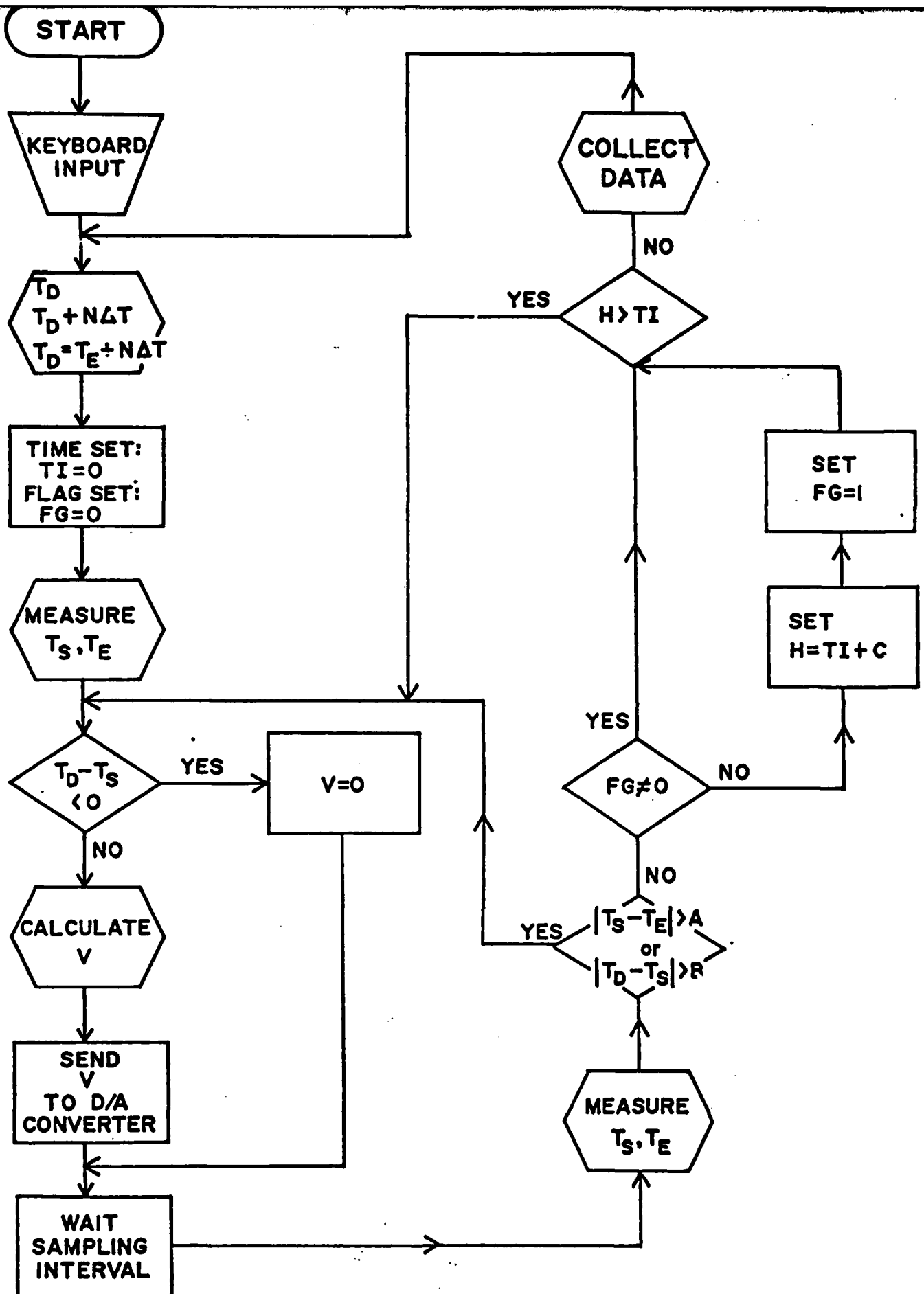
- Fig. 1. Vacuum thermostat: A, outer vacuum can; B, inner vacuum can or radiation shield; C, experimental stage; D, vacuum lines; E and F, vacuum connections and supports for radiation shield and experimental stage; G and H, flanges. The drawing is to scale, with the outer vacuum can being 18 in. (45cm.) high.
- Fig. 2. Hardware for temperature control and measurement system. T1 and T2 are resistance thermometers. R1 and R2 are standard resistors. The scanner and voltmeter read the voltage drops across T1, T2, R1, and R2. The computer calculates the temperature from the voltage drops, compares the actual temperatures to desired temperatures, then applies an appropriate voltage to the heater via the digital-to-analog converter and the programmable power supply.
- Fig. 3. Flow diagram of computer program for temperature measurement and control. The symbols are:  $T_D$ , desired radiation shield temperature; N, number of do-loops which increment  $T_D$  by an amount  $\Delta T$ ; TI, running real time on computer clock; FG, flag to indicate when temperature first comes to desired value;  $T_S$ , actual radiation shield temperature;  $T_E$ , actual experimental stage temperature; V, voltage applied to heater; A, allowed difference between  $T_S$  and

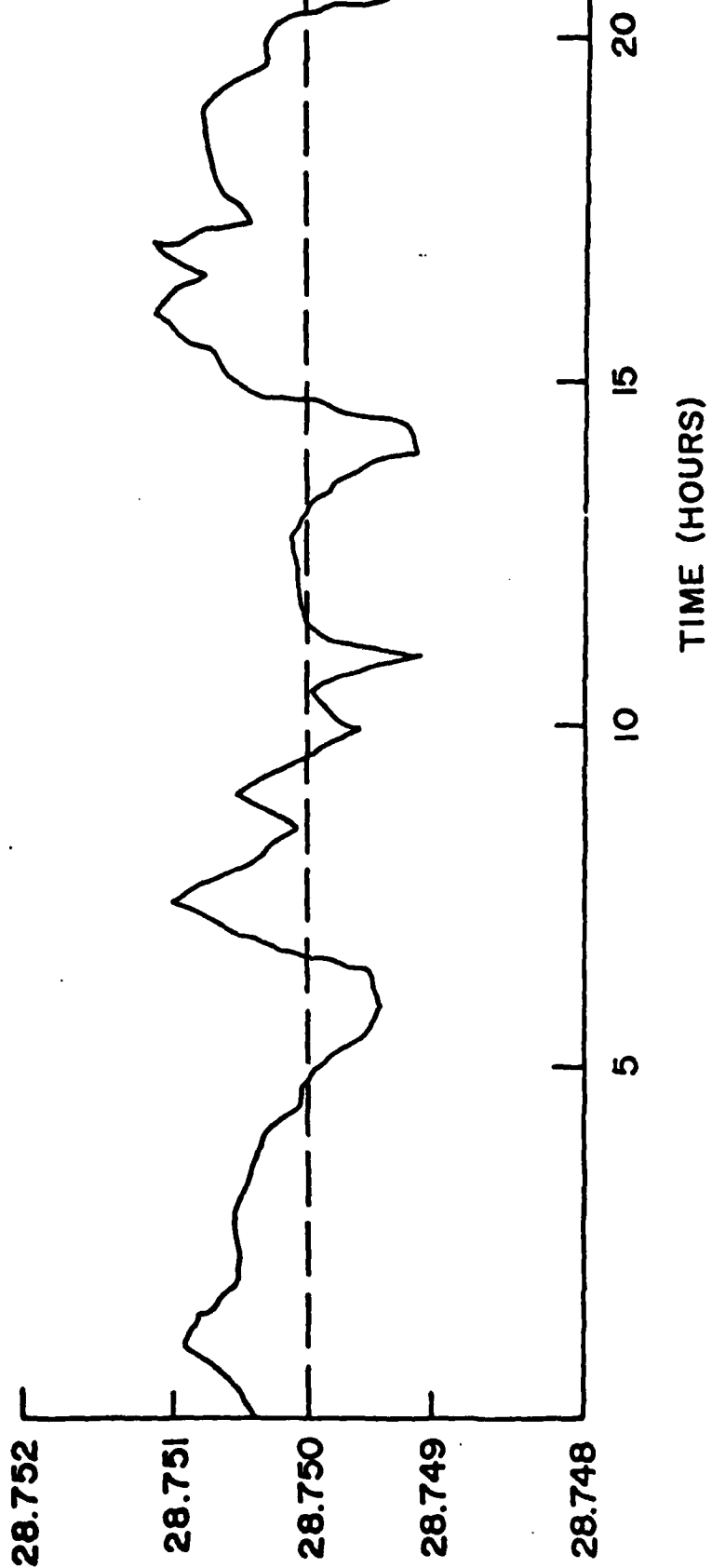
$T_E$  during control; B, allowed difference between  $T_D$  and  $T_S$  during control; C, equilibration time interval after control is achieved; H, real time at which data are to be collected.

Fig. 4. Temperature at the radiation shield as a function of time while under the control of the computer system. The temperature control at the experimental stage is probably considerably better.









TECHNICAL REPORT DISTRIBUTION LIST, 051B

	<u>No.</u> <u>Copies</u>		<u>No.</u> <u>Copies</u>
Professor K. Wilson Department of Chemistry, B-014 University of California, San Diego La Jolla, California 92093	1	Dr. B. Vonnegut State University of New York Earth Sciences Building 1400 Washington Avenue Albany, New York 12203	1
Professor C. A. Angell Department of Chemistry Purdue University West Lafayette, Indiana 47907	1	Dr. Hank Loos Laguna Research Laboratory 21421 Stans Lane Laguna Beach, California 92651	1
Professor P. Meijer Department of Physics Catholic University of America Washington, D.C. 20064	1	Dr. John Latham University of Manchester Institute of Science & Technology P.O. Box 88 Manchester, England M601QD	1
<del>Dr. S. Greer</del> <del>Chemistry Department</del> <del>University of Maryland</del> <del>College Park, Maryland 20742</del>	1		
Professor P. Delahay New York University 100 Washington Square East New York, New York 10003	1		
Dr. T. Ashworth Department of Physics South Dakota School of Mines & Technology Rapid City, South Dakota 57701	1		
Dr. G. Gross New Mexico Institute of Mining & Technology Socorro, New Mexico 87801	1		
Dr. J. Kassner Space Science Research Center University of Missouri - Rolla Rolla, Missouri 65401	1		
Dr. J. Telford University of Nevada System Desert Research Institute Lab of Atmospheric Physics Reno, Nevada 89507	1		

TECHNICAL REPORT DISTRIBUTION LIST, GEN

	<u>No.</u> <u>Copies</u>		<u>No.</u> <u>Copies</u>
Office of Naval Research Attn: Code 472 800 North Quincy Street Arlington, Virginia 22217	2	U.S. Army Research Office Attn: CRD-AA-IP P.O. Box 1211 Research Triangle Park, N.C. 27709	1
ONR Branch Office Attn: Dr. George Sandoz 536 S. Clark Street Chicago, Illinois 60605	1	Naval Ocean Systems Center Attn: Mr. Joe McCartney San Diego, California 92152	1
ONR Branch Office Attn: Scientific Dept. 715 Broadway New York, New York 10003	1	Naval Weapons Center Attn: Dr. A. B. Amster, Chemistry Division China Lake, California 93555	1
ONR Branch Office 1030 East Green Street Pasadena, California 91106	1	Naval Civil Engineering Laboratory Attn: Dr. R. W. Drisko Port Hueneme, California 93401	1
ONR Branch Office Attn: Dr. L. H. Peebles Building 114, Section D 666 Summer Street Boston, Massachusetts 02210	1	Department of Physics & Chemistry Naval Postgraduate School Monterey, California 93940	1
Director, Naval Research Laboratory Attn: Code 6100 Washington, D.C. 20390	1	Dr. A. L. Slafkosky Scientific Advisor Commandant of the Marine Corps (Code RD-1) Washington, D.C. 20380	1
The Assistant Secretary of the Navy (R,E&S) Department of the Navy Room 4E736, Pentagon Washington, D.C. 20350	1	Office of Naval Research Attn: Dr. Richard S. Miller 800 N. Quincy Street Arlington, Virginia 22217	1
Commander, Naval Air Systems Command Attn: Code 310C (H. Rosenwasser) Department of the Navy Washington, D.C. 20360	1	Naval Ship Research and Development Center Attn: Dr. G. Bosmajian, Applied Chemistry Division Annapolis, Maryland 21401	1
Defense Documentation Center Building 5, Cameron Station Alexandria, Virginia 22314	12	Naval Ocean Systems Center Attn: Dr. S. Yamamoto, Marine Sciences Division San Diego, California 91232	1
Dr. Fred Saalfeld Chemistry Division Naval Research Laboratory Washington, D.C. 20375	1	Mr. John Boyle Materials Branch Naval Ship Engineering Center Philadelphia, Pennsylvania 19112	1



TECHNICAL REPORT DISTRIBUTION LIST, GENNo.  
Copies

Dr. Rudolph J. Marcus  
Office of Naval Research  
Scientific Liaison Group  
American Embassy  
APO San Francisco 96503

1

Mr. James Kelley  
DTNSRDC Code 2803  
Annapolis, Maryland 21402

1